

Features

- 10.2 Gb/s HDMI 1.3 compatible
- 10.8 Gb/s DisplayPort V1.0 compatible
- 50Ω differential PECL input
- Pb-free and RoHS compliant
- Single 3.3V power supply operation
- Operating temperature range: 0°C to 70°C

Applications

- Multi-rate HDMI interfaces
- Multi-rate DisplayPort interfaces

Description

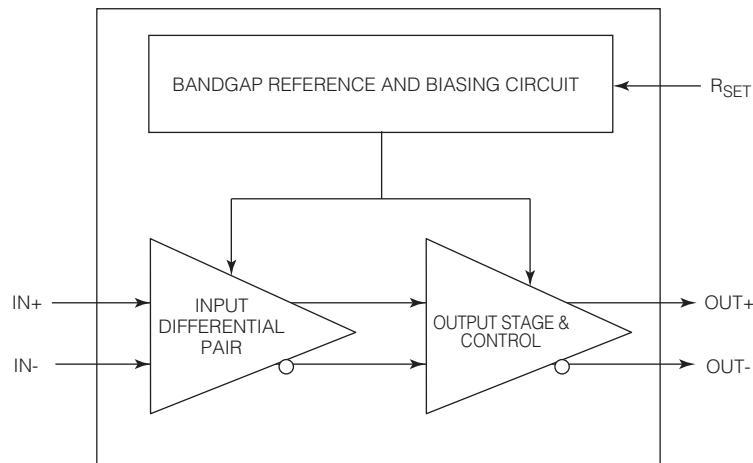
The GV8500 is a high-speed BiCMOS integrated circuit designed to drive 75Ω co-axial cables.

The GV8500 may drive data rates up to 3.4Gb/s for HDMI and DisplayPort applications.

The GV8500 accepts a LVPECL level differential input that may be AC coupled. External biasing resistors at the inputs are not required.

Power consumption is typically 168mW using a 3.3V power supply. The GV8500 is Pb-free, and the encapsulation compound does not contain halogenated flame retardant.

This component and all homogeneous subcomponents are RoHS compliant.



GV8500 Functional Block Diagram

Contents

Features	1
Applications	1
Description	1
1. Pin Out	3
1.1 Pin Assignment	3
1.2 Pin Descriptions	3
2. Electrical Characteristics	4
2.1 Absolute Maximum Ratings	4
2.2 DC Electrical Characteristics	4
2.3 AC Electrical Characteristics	5
2.4 Solder Reflow Profiles	6
3. Input / Output Circuits	7
4. Detailed Description	8
4.1 Input Interfacing	8
4.2 Output Interfacing	8
4.2.1 Output Amplitude (RSET)	8
5. Application Information	8
6. Package & Ordering Information	9
6.1 Package Dimensions	9
6.2 Recommended PCB Footprint	10
6.3 Packaging Data	10
6.4 Marking Diagram	11
6.5 Ordering Information	11
7. Revision History	12

1. Pin Out

1.1 Pin Assignment

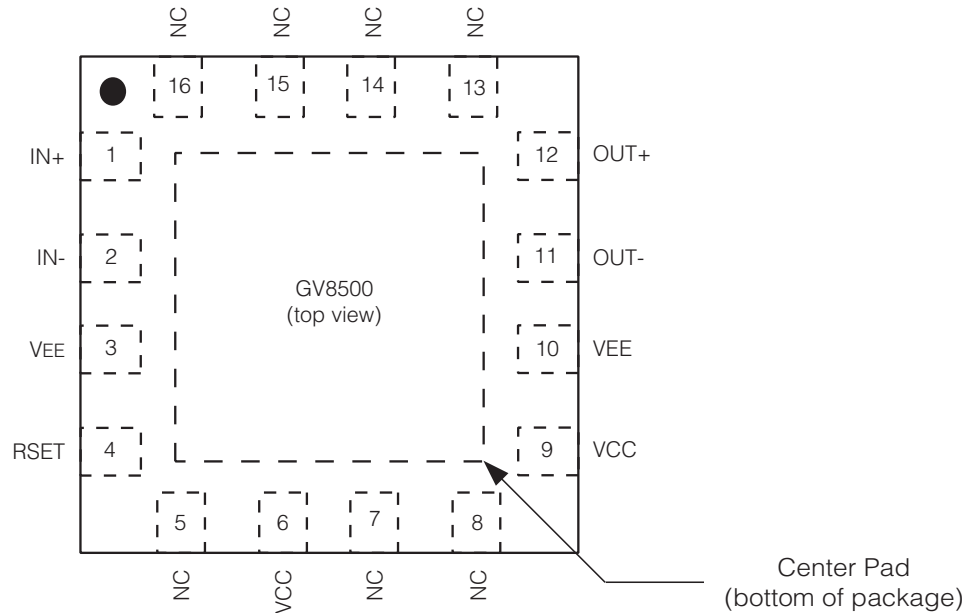


Figure 1-1: 16-Pin QFN

1.2 Pin Descriptions

Table 1-1: Pin Descriptions

Pin Number	Name	Timing	Type	Description
1,2	IN+, IN-	Analog	Input	Differential inputs.
3,10	V _{EE}	–	Power	Most negative power supply connection. Connect to GND.
4	R _{SET}	Analog	Input	External output amplitude control resistor.
5,7,8,13 14,15,16	NC	–	–	No Connect.
6,9	V _{CC}	–	Power	Most positive power supply connection. Connect to +3.3V.
11,12	OUT-, OUT+	Analog	Output	Differential outputs.
–	Center Pad	–	Power	Connect to most negative power supply plane following the recommendations in Recommended PCB Footprint on page 10 .

2. Electrical Characteristics

2.1 Absolute Maximum Ratings

Parameter	Value
Supply Voltage	-0.5V to 3.6 V _{DC}
Input ESD Voltage	4kV
Storage Temperature Range	-50°C < T _s < 125°C
Input Voltage Range (any input)	-0.3 to (V _{CC} +0.3)V
Operating Temperature Range	0°C to 70°C
Solder Reflow Temperature	260°C

NOTE: Absolute Maximum Ratings are those values beyond which damage to the device may occur. Functional operation under these conditions or at any other condition beyond those indicated in the AC/DC Electrical Characteristic sections is not implied.

2.2 DC Electrical Characteristics

Table 2-1: DC Electrical Characteristics

V_{CC} = 3.3V ±5%; T_A = 0°C to 70°C, unless otherwise shown

Parameter	Symbol	Conditions	Min	Typ	Max	Units
Supply Voltage	V _{CC}	–	3.135	3.3	3.465	V
Power Consumption	P _D	T _A = 25°C	–	168	–	mW
Supply Current	I _s	T _A = 25°C	–	51	–	mA
Output Voltage	V _{CMOUT}	Common mode	–	V _{CC} - V _{OUT}	–	V
Input Voltage	V _{CMIN}	Common mode	1.4 + ΔV _{DDI} /2	–	V _{CC} - ΔV _{DDI} /2	V

2.3 AC Electrical Characteristics

Table 2-2: AC Electrical Characteristics

$V_{CC} = 3.3V \pm 5\%$; $T_A = 0^\circ C$ to $70^\circ C$, unless otherwise shown

Parameter	Symbol	Conditions	Min	Typ	Max	Units	Notes
Serial Input Data Rate	DR	–	0.25	–	3.4	Gb/s	1
Serial Input Clock Rate	–	HDMI Clock, 1/10th Data Rate	25	–	340	MHz	–
Additive Jitter	–	3.4Gb/s	–	22	–	ps _{p-p}	–
	–	1.5Gb/s	–	20	–	ps _{p-p}	–
Rise/Fall Time	t_r, t_f	–	–	–	135	ps	2
Mismatch in Rise/Fall time	$\Delta t_r, \Delta t_f$	–	–	–	35	ps	–
Duty Cycle Distortion	–	–	–	–	30	ps	3
Overshoot	–	–	–	–	10	%	3
Output Voltage Swing	V_{OUT}	$R_{SET} = 750\Omega$	750	800	850	mV _{p-p}	3
Input Voltage Swing	ΔV_{DDI}	Differential	400	–	1560	mV _{p-p}	–

NOTES:

1. The input coupling capacitor must be set accordingly for lower data rates.
2. Rise/Fall time measured between 20% and 80%.
3. Single Ended into 75Ω external load.

2.4 Solder Reflow Profiles

The device is manufactured with Matte-Sn terminations and is compatible with both standard eutectic and Pb-free solder reflow profiles. MSL qualification was performed using the maximum Pb-free reflow profile shown in [Figure 2-1](#). The recommended standard Pb reflow profile is shown in [Figure 2-2](#).

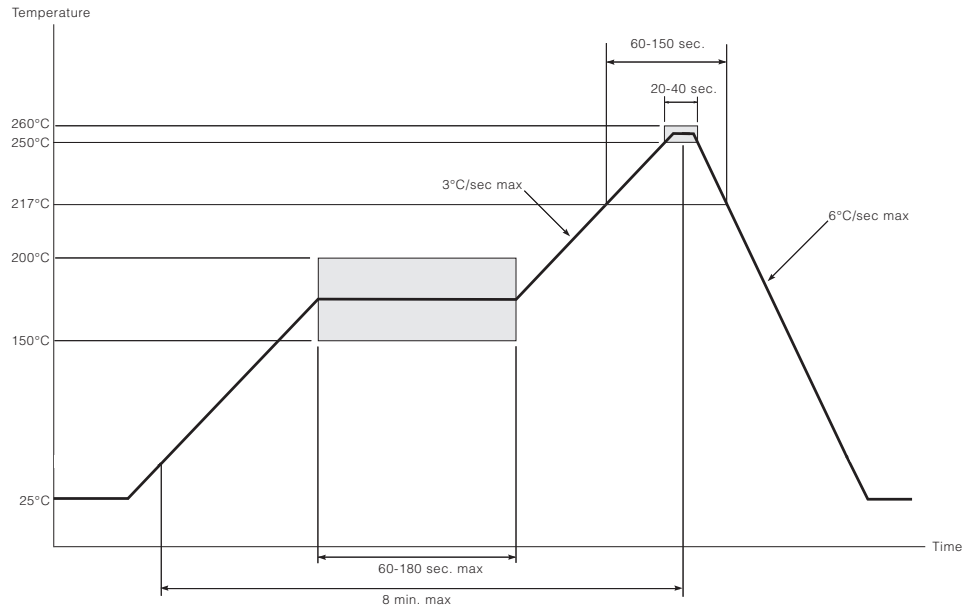


Figure 2-1: Maximum Pb-free Solder Reflow Profile (Preferred)

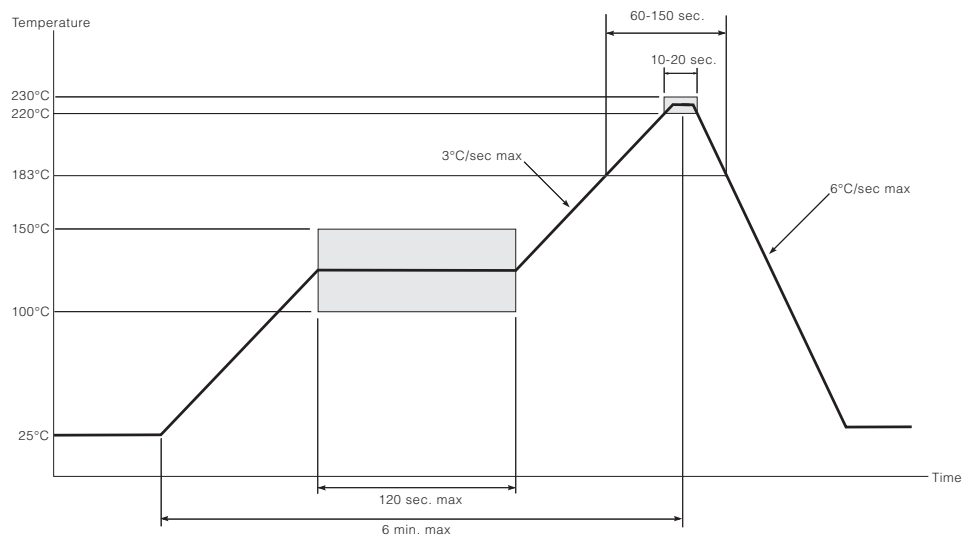


Figure 2-2: Standard Pb Reflow Profile

3. Input / Output Circuits

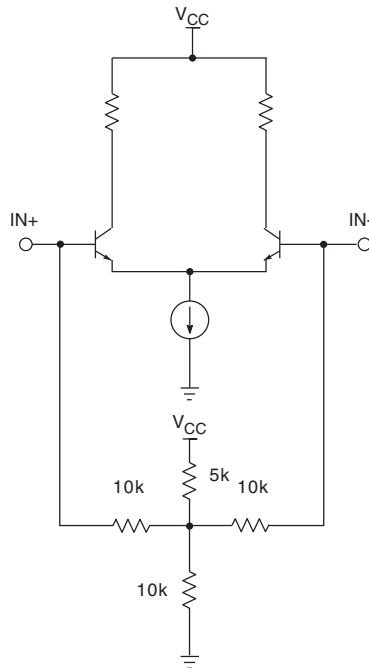


Figure 3-1: Differential Input Stage (IN+/IN-)

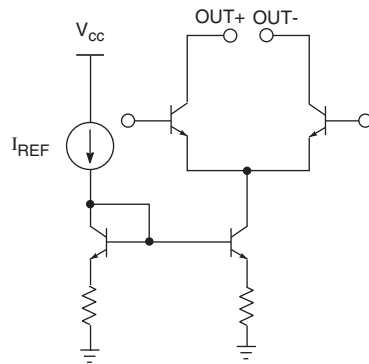


Figure 3-2: Differential Output Stage (OUT+/OUT-)

4. Detailed Description

4.1 Input Interfacing

IN+/IN- are high impedance differential inputs. The equivalent input circuit is shown in [Figure 3-1](#).

Several conditions must be observed when interfacing to these inputs:

- The differential input signal amplitude must be between 400 and 1560mVpp.
- The common mode voltage range must be as specified in the [DC Electrical Characteristics on page 4](#).
- For input trace lengths longer than approximately 1cm, the inputs should be terminated as shown in the Typical Application Circuit.

The GV8500 inputs are self-biased, allowing for simple AC coupling to the device.

4.2 Output Interfacing

The GV8500 outputs are current mode, and will drive typically 800mV into a 75 Ω load. These outputs are protected from accidental static damage with internal ESD protection diodes.

4.2.1 Output Amplitude (RSET)

The output amplitude of the GV8500 is set by the value of the R_{SET} resistor. In order to produce an 800mV_{p-p} output with a nominal $\pm 7\%$ tolerance, a value of 750 Ω is required. A $\pm 1\%$ SMT resistor should be used.

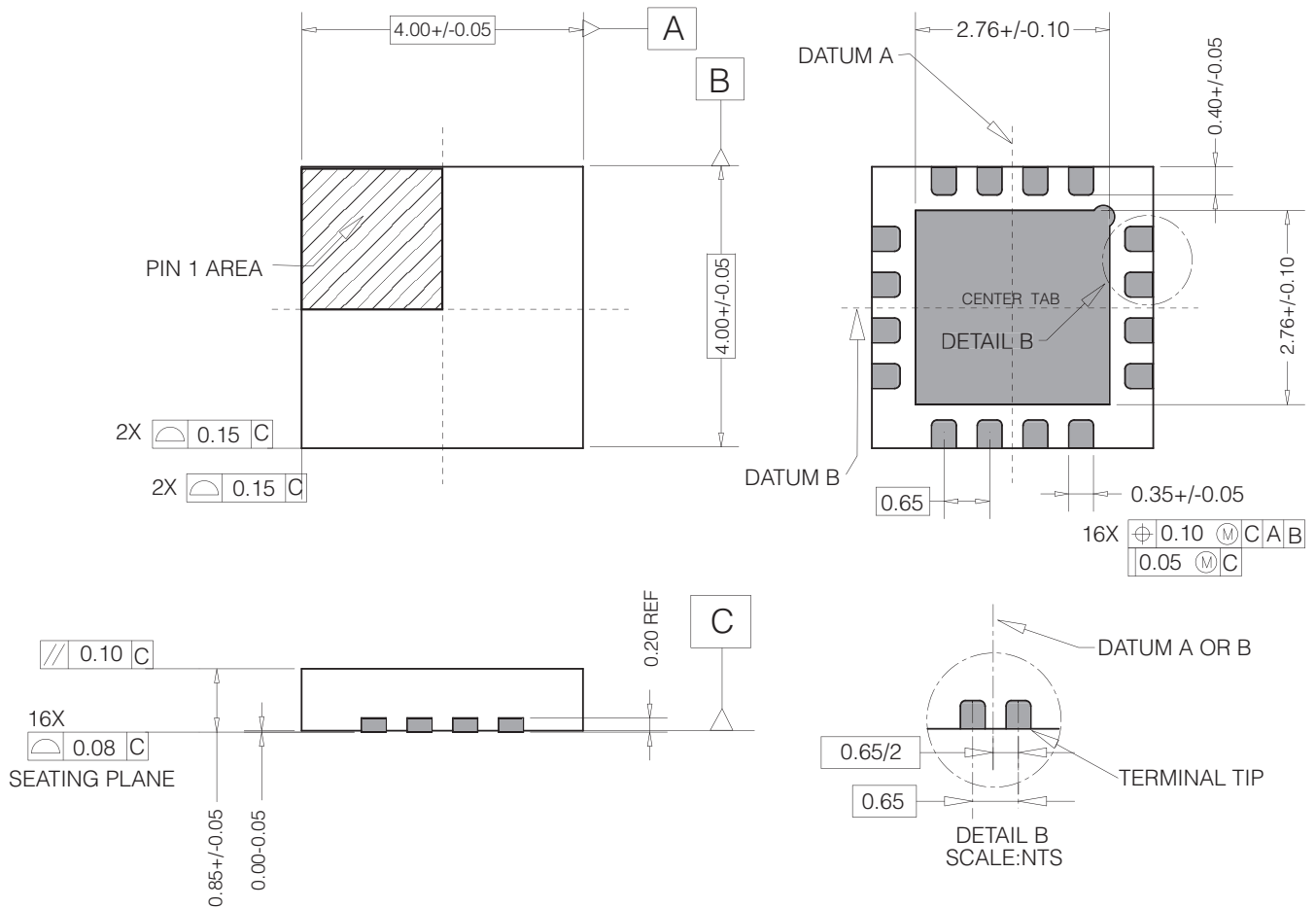
The R_{SET} resistor is part of the high speed output circuit of the GV8500. The resistor should be placed as close as possible to the R_{SET} pin. In addition, the PCB capacitance should be minimized at this node by removing the PCB groundplane beneath the R_{SET} resistor and the R_{SET} pin.

5. Application Information

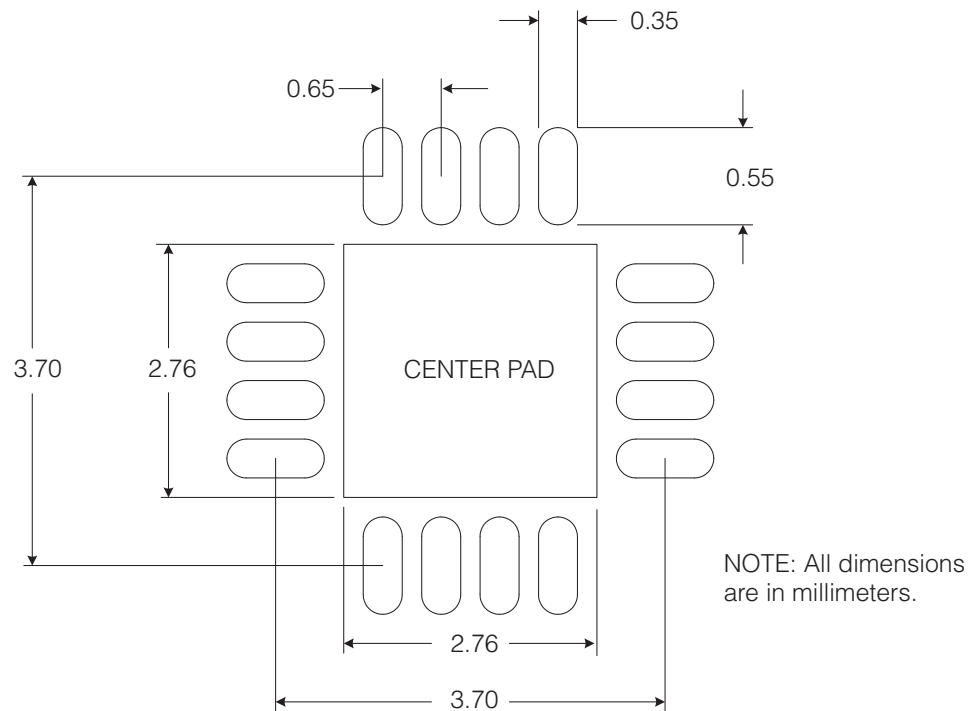
Contact vbapps@gennum.com for information

6. Package & Ordering Information

6.1 Package Dimensions



6.2 Recommended PCB Footprint



The Center Pad should be connected to the most negative power supply plane (VEE) by a minimum of 5 vias.

NOTE: Suggested dimensions only. Final dimensions should conform to customer design rules and process optimizations.

6.3 Packaging Data

Parameter	Value
Package Type	4mm x 4mm 16-pin QFN
Package Drawing Reference	JEDEC M0220
Moisture Sensitivity Level	3
Junction to Case Thermal Resistance, θ_{j-c}	31.0°C/W
Junction to Air Thermal Resistance, θ_{j-a} (at zero airflow)	43.8°C/W
Psi, Ψ	11.0°C/W
Pb-free and RoHS compliant	Yes

6.4 Marking Diagram

Pin 1 Indicator



XXXX - Lot/Work Order ID
 YYWW - Date Code
 YY - 2-digit year
 WW - 2-digit week number

6.5 Ordering Information

	Part Number	Package	Temperature Range
GV8500	GV8500-CNE3	16-pin QFN	0°C to 70°C

7. Revision History

Version	ECR	PCN	Date	Changes and/or Modifications
A	148086	–	October 2007	New document.

CAUTION

ELECTROSTATIC SENSITIVE DEVICES
DO NOT OPEN PACKAGES OR HANDLE
EXCEPT AT A STATIC-FREE WORKSTATION



DOCUMENT IDENTIFICATION
ADVANCE INFORMATION NOTE

The product is in a development phase and specifications are subject to change without notice. Gennum reserves the right to remove the product at any time. Listing the product does not constitute an offer for sale.

GENNUM CORPORATION

Mailing Address: P.O. Box 489, Stn. A, Burlington, Ontario, Canada L7R 3Y3
Shipping Address: 970 Fraser Drive, Burlington, Ontario, Canada L7L 5P5
Tel. +1 (905) 632-2996 Fax. +1 (905) 632-5946

GENNUM JAPAN CORPORATION

Shinjuku Green Tower Building 27F, 6-14-1, Nishi Shinjuku, Shinjuku-ku, Tokyo, 160-0023 Japan
Tel. +81 (03) 3349-5501, Fax. +81 (03) 3349-5505

GENNUM UK LIMITED

25 Long Garden Walk, Farnham, Surrey, England GU9 7HX
Tel. +44 (0)1252 747 000 Fax +44 (0)1252 726 523

Gennum Corporation assumes no liability for any errors or omissions in this document, or for the use of the circuits or devices described herein. The sale of the circuit or device described herein does not imply any patent license, and Gennum makes no representation that the circuit or device is free from patent infringement.

GENNUM and the G logo are registered trademarks of Gennum Corporation.

© Copyright 2007 Gennum Corporation. All rights reserved. Printed in Canada.

www.gennum.com